

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	R0730- TTR8MFTTF00S8A		
JI LONION SHEET NO.			
DATE	July 30,	2024	
REVISION	A2	Updated With Most Recent Data	
	SMD Glass Passivated Bridge Rectifier, TTR Series, Case TTF Type,		
DESCRIPTION AND		Voltage 1000V Max. Forward Current 8.0 A Max	
MAIN PARAMETRICS		ng Temp. Range -55°C ~+150°C	
	Package	in Tape/Reel, 3000pcs/Reel	
	RoHS III/REACH Compliant and Halogen Free (HF)		
CUSTOMER			
CUSTOMER PART NO.			
CROSS REF. PART NO.			
ORIGINAL MFG/PART NO.	MDD Diodes/TTR8MF		
PART CODE	TTR8MFTTF00S8A		

VENDOR APPROVE

Issued/Checked/Approved







DATE: July. 30, 2024

CUSTOMER APPROVE	
DATE:	



SMD GLASS PASSIVATED BRIDGE RECTIFER TTR SERIES CASE TTF

MAIN FEATURE

- · Glass Passivated Chip Junction
- Reverse Voltage 1000 V
- Forward Current 8.0 A
- REACH/RoHS III Complaint and Halogen Free
- Fast Reverse Recovery Time
- APPLICATION
- Designed for Surface Mount Application
- ELECTRICAL CHARACTERISTICS
- See Page 4~ Page 5

HOW TO ORDER

Please Follow Up Part Code Guide And Indicate Pat Code When You Order Or RFQ For Custom Specification

PART CODE GUIDE



CODE	NAME	KEY SPECIFICATION OPTION
TTR	Product Series Code	SMD Glass Passivated Bridge Rectifiers, TTR Series
8MF	Specification Code	For Voltage Range - 1000 V, Current - 8.0 A
TTF	Case Code	Case TTF
00\$	Internal Control Code	Custom letter A~Z, a-z or Digits (0-9)
8A	Marking Code	Custom letter A~Z, a-z or Digits (0-9) for Marking "8A"

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DIMENSION (Unit: Inch/mm)

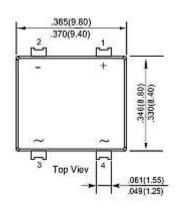
Image for reference

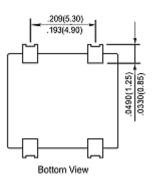


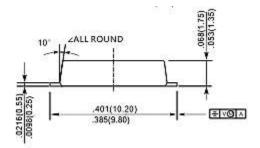
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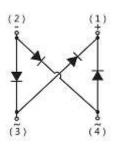
8A

Case TTF

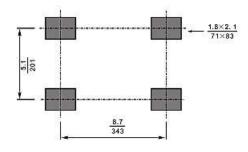








Recommend Pad Layout





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MECHANICAL DATA

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC Constant	Solderable per MIL-	Polarity symbol	Any	0.0163 ounce,
Case TTF Molded plastic body	STD-750, Method 2026	Marking on body		0.461 grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS - @ 25 °C

PARAMETER	SYMBOLS	VALUE	UNITS
Maximum Recurrent Peak Reverse Voltage	Vrrm	1000	V
Maximum RMS Voltage	Vrms	700	V
Maximum DC Blocking Voltage	VDC	1000	V
Average Rectified Output Current at Tc = 100°C	lo	8.0	А
Peak Forward Surge Current, 8.3ms Single Half	IFSM	220	А
Sine-wave Superimposed on Rated Load			
(JEDEC method)			
IPeak Forward Surge Current 1.0ms Single	lfsm	350	A
Half Sine-wave Superimposed on Rated Load			
Rating for Fusing	l²t	220	A ² S
Typical Thermal Resistance (Note 2)	Reja	60	°C/W
	Rejc	6	
	Rejl	14	
Operating and Storage Temperature Range	Tj, Tstg	-55 ~ +1 50	°C

Note:

- 1. Single Phase Half-wave 60hz, resistive Or Inductive Load, For Capacitive Load Current Derate By 20%.
- 2. Measured At 1mhz And Applied Reverse Voltage Of 4 V D.C.
- 3. P.C.B. Mounted With 4 \times 1.5" \times 1.5" (3.81 \times 3.81 Cm) copper Pad Areas. 7/30/2024



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS- @ 25 °C

PARAMETER	SYMBOL	TEST CONDITIONS	VALUE		UNITS	
			Min.	Тур.	Max.	
Instantaneous Forward Voltage	VF	IF =1A TJ=25°C	-	0.83	-	v
		IF =4A TJ=25°C	-	0.95	1.1	
		IF =1A TJ=125°C	-	0.70	-	
		IF =4A TJ=125°C	-	0.85	-	
Reverse Current At DC Blocking	IR	TJ=25°C	-	0.15	1.0	μΑ
Voltage		TJ=125°C	-	40	200	
Maximum Reverse Recovery	trr	Measured with	-	-	500	ns
Time		IF = 0.5 A, IR = 1 A,				
		Irr = 0.25 A				
Typical Junction Capacitance	Cj	f=1MHz,VR=4V DC	-	60	-	pF
		TJ=25°C				

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TYPICAL CHARACTERISTIC CURVES - For Reference Only

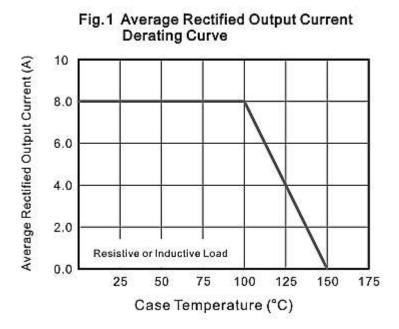
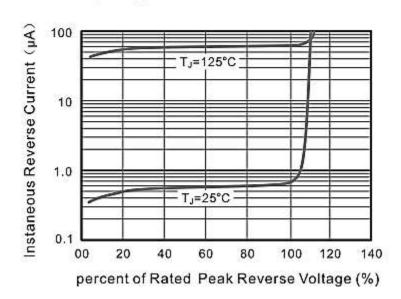


Fig.2 Typical Reverse Characteristics



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TYPICAL CHARACTERISTIC CURVES - For Reference Only

Fig.3 Typical Instaneous Forward Characteristics

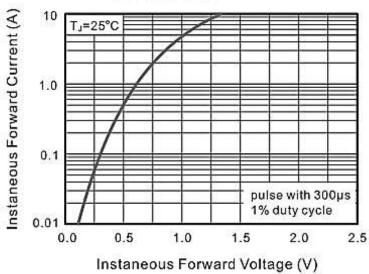
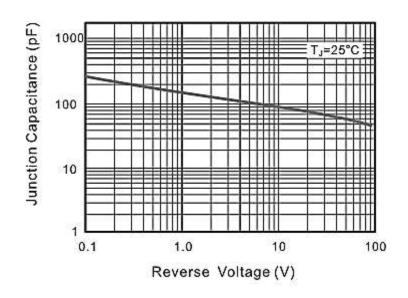


Fig.4 Typical Junction Capacitance



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TYPICAL CHARACTERISTIC CURVES - For Reference Only

Fig.5 Maximum Non-Repetitive Peak Forward Surage Current 240 Peak Forward Surage Current (A) 210 180 150 120 90 60 30 8.3 ms Single Half Sine Wave (JEDEC Method) 00 10 100 Number of Cycles at 60Hz

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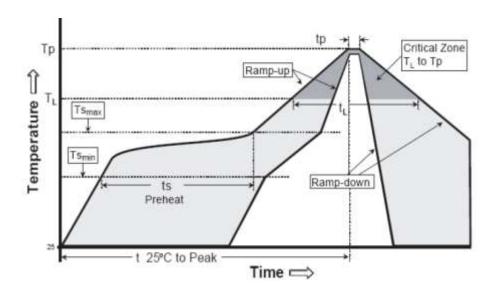
RELIABILITY

		1	
NUMBER	EXPERIMENT ITEMS	EXPERIMENT METHOD AND CONDITIONS	REFERENCE DOCUMENTS
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, Ta=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	Ta=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

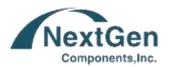


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SUGGESTED REFLOW PROFILE - For Reference Only

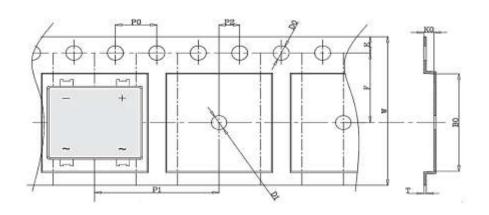


PROFILE FEATURE		PB-FREE ASSEMBLY	
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max	
Preheat	Temperature Min (Ts Min.)	150°C	
	Temperature Max (Ts Max.)	200°C	
	Time (ts Min. to ts Max.)	60~120 seconds	
Time maintained	Temperature (TL)	217°C	
above	Time (tL)	60∼150 seconds	
Peak/Classification Temperature (Tp)		260 +/-5°C	
Time within 5°C of actual Peak Temperature (tp)		20~40 seconds	
Ramp-down rate		6 °C /Second Max.	
Time 25 °C to Peak Temperature		8 minutes Max.	
Suggest reflow times		3 Times Max.	

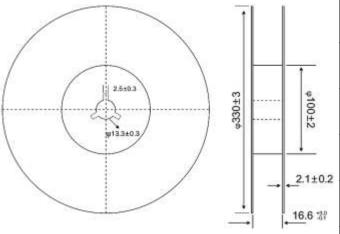


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TAPE/REEL (Unit: mm) All Devices are packed in accordance with EIA standard RS-481-A and specifications.







ITEM	SYMBOL	TOL.	CASE TTF	
Carrier Width	A0	0.10	10.1	
Carrier Length	ВО	0.10	10.5	
Carrier Depth	КО	0.10	1.85	
Sprocket Hole Pitch	PO	0.10	4.00	
Punch Hole Pitch	P1	0.10	12.00	
Embossment Center	P2	0.05	2.00	
Overall Tape Thickness	Т	0.03	0.30	
Sprocket Hole Position	E	0.10	1.75	
Punch Hole Position	F	0.05	7.50	
Sprocket Hole	D0	0.05	1.55	
Punch Hole	D1	0.25	1.50	
Tape Width	W	+0.30/ -0.10	16.0	
Qty. /Reel	3000pcs			



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IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
 concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
 exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
 this product can be obtained can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.
- All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test
 conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
 Characteristics if operated under different conditions.
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